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Silicon Carbide (SiC) Module – 30 mohm SiC M3S MOSFET, 1200 V, 4-PACK Full Bridge Topology, F1 Package

Product Preview NXH030F120M3F1PTG

The NXH030F120M3F1PTG is a power module containing $30 \text{ m}\Omega/1200 \text{ V}$ SiC MOSFET full-bridge and a thermistor with Al₂O₃ DBC in an F1 package.

Features

- $30 \text{ m}\Omega / 1200 \text{ V}$ M3S SiC MOSFET Full-Bridge
- Al₂O₃ DBC
- Thermistor
- Options with Pre-Applied Thermal Interface Material (TIM) and without Pre-Applied TIM
- Options with Solderable Pins and Press-Fit Pins
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

Typical Applications

- Solar Inverter
- Uninterruptible Power Supplies
- Electric Vehicle Charging Stations
- Industrial Power

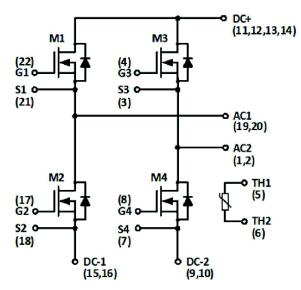
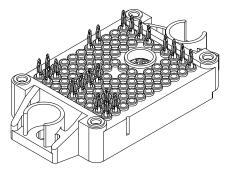


Figure 1. NXH030F120M3F1PTG Schematic Diagram

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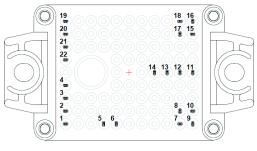
PIM22 33.8x42.5 (PRESS FIT) CASE 180HL

MARKING DIAGRAM



NXH030F120M3F1PTG = Specific Device Code AT = Assembly & Test Site Code YYWW = Year and Work Week Code

PIN CONNECTIONS



See Pin Function Description for pin names

ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

PIN FUNCTION DESCRIPTION

Pin	Name	Description			
1	AC2	Center point of full bridge 2			
2	AC2	Center point of full bridge 2			
3	S3	M3 Kelvin Source (High Side switch)			
4	G3	M3 Gate (High Side switch)			
5	TH1	Thermistor Connection 1			
6	TH2	Thermistor Connection 2			
7	S4	M4 Kelvin Source (Low side switch)			
8	G4	M4 Gate (Low side switch)			
9	DC-2	DC Negative Bus connection			
10	DC-2	DC Negative Bus connection			
11	DC+	DC Positive Bus connection			
12	DC+	DC Positive Bus connection			
13	DC+	DC Positive Bus connection			
14	DC+	DC Positive Bus connection			
15	DC-1	DC Negative Bus connection			
16	DC-1	DC Negative Bus connection			
17	G2	M2 Gate (Low side switch)			
18	S2	M2 Kelvin Source (Low side switch)			
19	AC1	Center point of full bridge 1			
20	AC1	Center point of full bridge 1			
21	S1	M1 Kelvin Source (High side switch)			
22	G1	M1 Gate (High side switch)			

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
SIC MOSFET	·····		
Drain-Source Voltage	V _{DSS}	1200	V
Gate-Source Voltage	V _{GS}	+22/-10	V
Continuous Drain Current @ $T_C = 80^{\circ}C$ ($T_J = 175^{\circ}C$)	I _D	38	А
Pulsed Drain Current (T _J = 175°C)	I _{Dpulse}	115	А
Maximum Power Dissipation ($T_J = 175^{\circ}C$)	P _{tot}	100	W
Minimum Operating Junction Temperature	T _{JMIN}	-40	°C
Maximum Operating Junction Temperature	T _{JMAX}	175	°C
THERMAL PROPERTIES			
Storage Temperature Range	T _{stg}	-40 to 150	°C
INSULATION PROPERTIES			
Isolation Test Voltage, t = 1 s, 60 Hz	V _{is}	4800	V _{RMS}
Creepage Distance		12.7	mm
CTI		600	
Substrate Ceramic Material		Al ₂ O ₃	
Substrate Ceramic Material Thickness		0.32	mm

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe Operating parameters.



RECOMMENDED OPERATING RANGES

Rating	Symbol	Min	Max	Unit
Module Operating Junction Temperature		-40	150	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS (T_J = 25 °C unless otherwise noted)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit	
SIC MOSFET CHARACTERISTICS	•	•					
Zero Gate Voltage Drain Current	V_{GS} = 0 V, V_{DS} = 1200 V, T_{J} = 25°C	I _{DSS}	-	-	100	μA	
Drain-Source On Resistance	V_{GS} = 18 V, I _D = 30 A, T _J = 25°C	R _{DS(ON)}	-	30.6	38.5	mΩ	
	V_{GS} = 18 V, I _D = 30 A, T _J = 125°C	1	_	51.1	_	1	
	V_{GS} = 18 V, I _D = 30 A, T _J = 150°C		_	59.3	_	1	
	V_{GS} = 18 V, I _D = 30 A, T _J = 175°C		_	68.2	_	1	
Gate-Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 15 \text{ mA}$	V _{GS(TH)}	2.04	2.6	4.4	V	
Recommended Gate Voltage		V _{GOP}	-3	-	+18	V	
Gate-to-Source Leakage Current	$V_{GS} = +22/-10$ V, $V_{DS} = 0$ V	I _{GSS}	-	-	±1	μA	
Input Capacitance	$V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ Mhz}, V_{DS} = 800 \text{ V}$	C _{ISS}	-	2246	-	pF	
Reverse Transfer Capacitance	-	C _{RSS}	-	12.1	-	1	
Output Capacitance	-	C _{OSS}	-	156	-	1	
Total Gate Charge	$V_{GS} = -3/18$ V, $V_{DS} = 800$ V, $I_{D} = 30$ A	Q _{G(TOTAL)}	-	110	-	nC	
Gate-Source Charge	-	Q _{GS}	_	19	_	1	
Gate-Drain Charge	-	Q _{GD}	-	30	-	1	
Internal Gate Resistance	f = 1 MHz	R _{GINT}	-	3.3	-	Ω	
Turn-on Delay Time	$T_{\rm J} = 25^{\circ} {\rm C},$	t _{d(on)}	-	40.4	-	ns	
Rise Time	$V_{DS} = 800 \text{ V}, \text{ I}_D = 30 \text{ A},$ $V_{GS} = -3 \text{ V}/18 \text{ V}, \text{ R}_G = 4.7 \Omega$	t _r	-	9	-	1	
Turn-off Delay Time	1	t _{d(off)}	-	109.5	-	1	
Fall Time	-	t _f	_	9.3	-	1	
Turn-on Switching Loss per Pulse	-	E _{ON}	_	520	-	μJ	
Turn off Switching Loss per Pulse	7	E _{OFF}	-	80	-	1	
Turn-on Delay Time	$T_{J} = 150^{\circ}C,$	t _{d(on)}	_	39.9	-	ns	
Rise Time	$V_{DS} = 800 \text{ V}, \text{ I}_{D} = 30 \text{ A},$ $V_{GS} = -3 \text{ V}/18 \text{ V}, \text{ R}_{G} = 4.7 \Omega$	t _r	_	6.8	-	1	
Turn-off Delay Time	1	t _{d(off)}	_	118.1	-	1	
Fall Time	-	t _f	-	8.7	-	1	
Turn-on Switching Loss per Pulse	-	E _{ON}	-	750	-	μJ	
Turn off Switching Loss per Pulse	7	E _{OFF}	-	96	_	1	
Diode Forward Voltage	$V_{GS} = -3 \text{ V}, \text{ I}_{SD} = 30 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$	V _{SD}	-	4.67	6	V	
	V_{GS} = –3 V, I_{SD} = 30 A, T_J = 125°C	1	_	4.45	_	1	
	V_{GS} = –3 V, I_{SD} = 30 A, T_J = 150°C	1	_	4.4	_	1	
Thermal Resistance - Chip-to-Case	M1, M2	R _{thJC}	_	0.95	_	°C/W	
Thermal Resistance - Chip-to-Heatsink		R _{thJH}	_	1.54	-	°C/W	



ELECTRICAL CHARACTERISTICS (continued)(T_J = 25 °C unless otherwise noted)

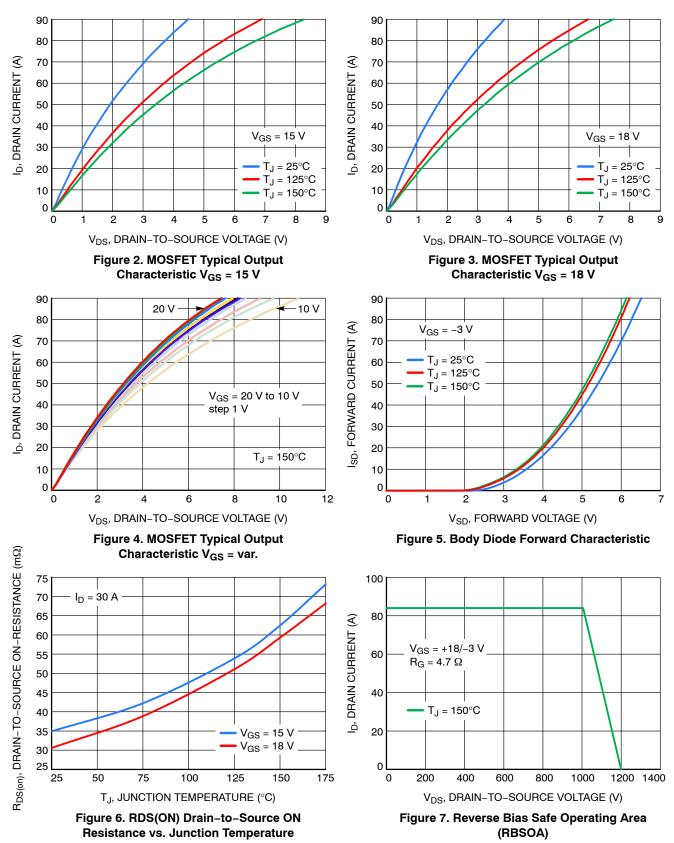
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit		
THERMISTOR CHARACTERISTICS								
Nominal Resistance	T = 25°C	R ₂₅	_	5	_	kΩ		
	T = 100°C	R ₁₀₀	_	493	_	Ω		
	T = 150°C	R ₁₅₀	-	159.5	-	Ω		
Deviation of R ₁₀₀	T = 100°C	$\Delta R/R$	-5	-	5	%		
Power Dissipation – Recommended Limit	0.15 mA, Non-self-heating Effect	PD	-	0.1	-	mW		
Power Dissipation – Absolute Maximum	5 mA	PD	-	34.2	-	mW		
Power Dissipation Constant			-	1.4	-	mW/K		
B-value	B (25/50), tolerance ±2%		-	3375	-	к		
B-value	B (25/100), tolerance ±2%		-	3436	-	К		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

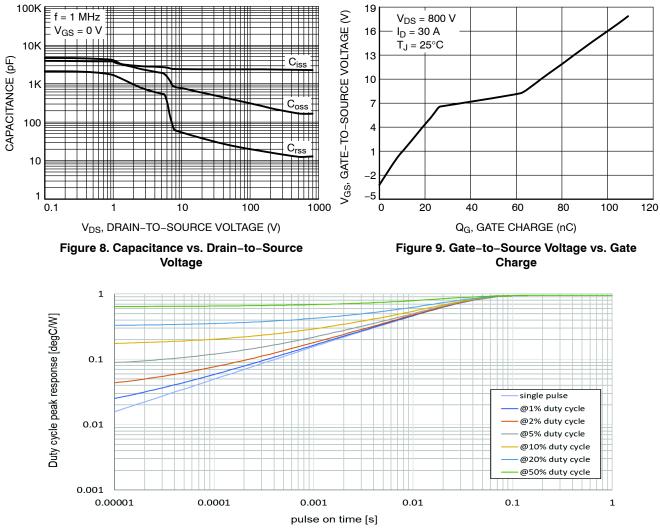
Orderable Part Number	Marking	Package	Shipping
NXH030F120M3F1PTG	NXH030F120M3F1PTG	F1FULLBR: Case 180HL Press-fit Pins with pre-applied thermal interface material (TIM) (Pb-Free and Halide-Free)	28 Units / Blister Tray



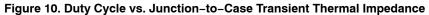


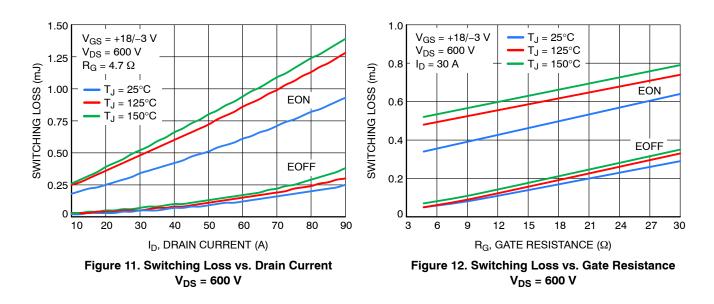
TYPICAL CHARACTERISTICS M1/M2 SIC MOSFET CHARACTERISTIC





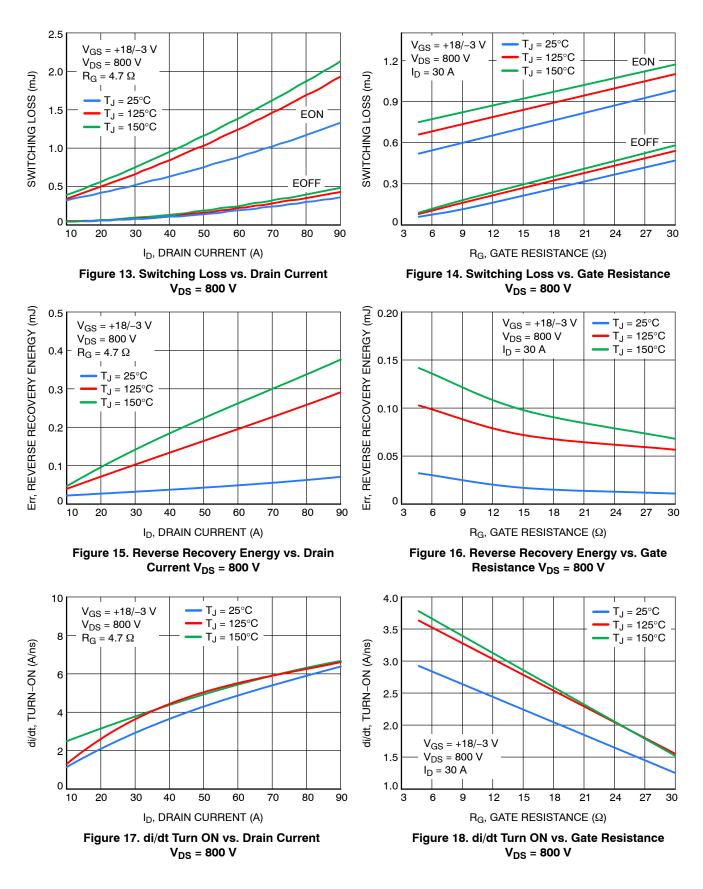
TYPICAL CHARACTERISTICS M1/M2 SIC MOSFET CHARACTERISTIC







TYPICAL CHARACTERISTICS M1/M2 SIC MOSFET CHARACTERISTIC





TYPICAL CHARACTERISTICS M1/M2 SIC MOSFET CHARACTERISTIC

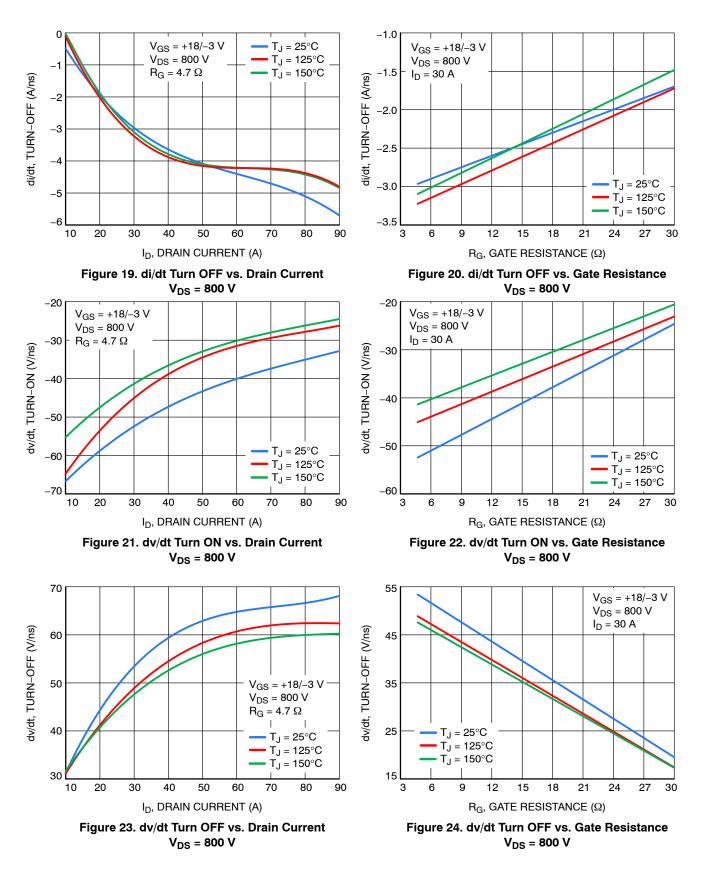


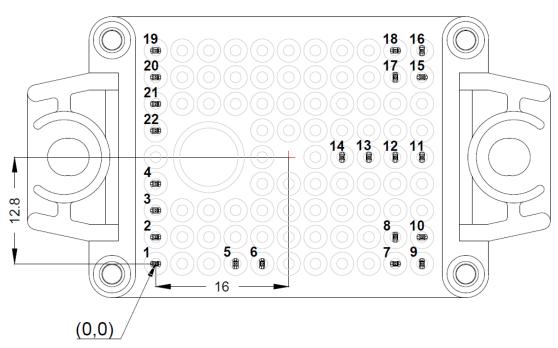


Table 1. CAUER NETWORKS

Cauer Element #	Rth (K/W)	Cth (Ws/K)		
1	0.0008598	0.0006888		
2	0.0060273	0.0001577		
3	0.0131590	0.0002630		
4	0.0651160	0.0013257		
5	0.1977800	0.0040903		
6	0.3716200	0.0208140		
7	0.1618000	0.5875200		

PIN POSITION INFORMATION

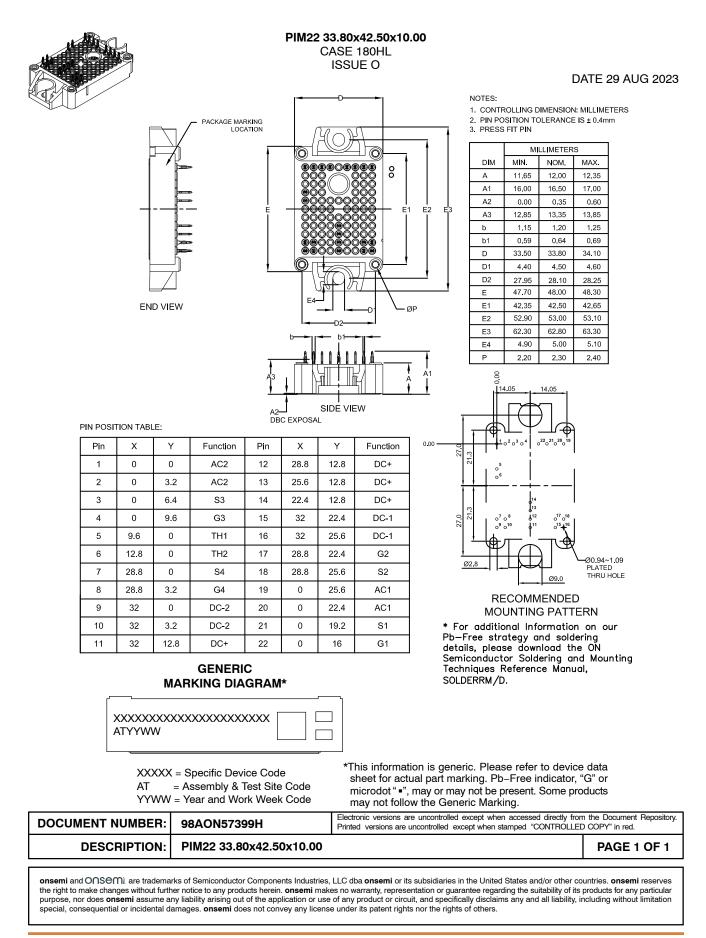
scale = 2.5 : 1



Pin position

Pin #	X	Y	Function	Pin #	X	Y	Function
1	0	0	AC2	12	28.8	12.8	DC+
2	0	3.2	AC2	13	25.6	12.8	DC+
3	0	6.4	S3	14	22.4	12.8	DC+
4	0	9.6	G3	15	32	22.4	DC-1
5	9.6	0	TH1	16	32	25.6	DC-1
6	12.8	0	TH2	17	28.8	22.4	G2
7	28.8	0	S4	18	28.8	25.6	S2
8	28.8	3.2	G4	19	0	25.6	AC1
9	32	0	DC-2	20	0	22.4	AC1
10	32	3.2	DC-2	21	0	19.2	S1
11	32	12.8	DC+	22	0	16	G1

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